

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	161	"134"/\$.ccls. and (acetone with dry\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 13:33
L3	0	"134"/\$.ccls. and (cryogenic with (thickness near3 layer))	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 13:49
L4	1	("5062898").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/10/04 13:35
L5	1	"134"/\$.ccls. and (cryogenic with (thickness))	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 13:53
L6	30	"134"/\$.ccls. and (cryogenic with (layer))	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 14:35
L7	0	"134"/\$.ccls. and (cryogenic with (layer near3 thickness))	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 15:03
L8	6	"134"/\$.ccls. and (cryogenic same (layer near3 thickness))	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 15:04
L9	0	"134"/\$.ccls. and (cryogenic with liquid with angstroms)	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 15:05
L10	7	"134"/\$.ccls. and (cryogenic with liquid near2 (thickness or layer))	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 15:11
L11	0	"134"/\$.ccls. and (cryogenic with angstroms)	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 15:11
L12	0	"134"/\$.ccls. and (cryogenic with micrometers)	US-PGPUB; USPAT; USOCR	OR	ON	2007/10/04 15:14
L14	1	("5456758").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/10/04 15:15
L15	1	("4,515,704").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/10/04 15:29
L16	1	("5066616").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/10/04 15:29

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S1	37	("4264641" "5315793" "5316560" "5354384" "5377705" "5409418" "5561527" "5611491" "5637027" "5766061" "5766368" "5775127" "5796111" "5804826" "5806544" "5836809" "5837064" "5853962" "5908510" "5931721" "5961732" "5967156" "5989355" "6004400" "6033484" "6036581" "6066032" "6099396" "6146466" "6173916" "6203406" "6231771" "6231775" "6306564" "6332470" "6500758" "6565920").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 12:58
S2	15	(precision near2 clean\$4) with (cryogenic\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 13:24
S4	1	("6333268").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/10/04 13:20
S5	1	("6949145").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/27 13:16
S6	4	(precision near2 clean\$4) with (dens\$4 or compress\$3 or pressur\$4) with (cryogenic\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 13:27
S7	391	(clean\$4 or treat\$4 or rins\$4 or etch\$4) with (dens\$4 or compress\$3 or pressur\$4) with (cryogenic\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 14:03
S8	40	(clean\$4 or treat\$4 or rins\$4 or etch\$4) with (dens\$4 or compress\$3 or pressur\$4) with (cryogenic\$4) with (substrate or semiconductor or electronic or wafer or workpiece)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 14:10
S9	1	(clean\$4 or treat\$4 or rins\$4 or etch\$4) with (dens\$4 or compress\$3 or pressur\$4) with (cryogenic\$4) with (substrate or semiconductor or electronic or wafer or workpiece) with (ethanol or acetone)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 14:17
S10	1	(cryogenic\$4) with (substrate or semiconductor or electronic or wafer or workpiece) with (ethanol or acetone)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 14:21
S11	0	(wet near2 clean\$4) same (cryogenic\$4) same (substrate or semiconductor or electronic or wafer or workpiece) with (ethanol or acetone)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 14:22

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S12	0	(wet near2 clean\$4) with (cryogenic\$4) with (substrate or semiconductor or electronic or wafer or workpiece) with (ethanol or acetone)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 14:23
S13	0	((wet or aqueous) near2 clean\$4) with (cryogenic\$4) with (substrate or semiconductor or electronic or wafer or workpiece) with (ethanol or acetone)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 14:23
S14	55	((wet or aqueous) near2 clean\$4) and (cryogenic\$4) and (substrate or semiconductor or electronic or wafer or workpiece) and (ethanol or acetone)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 14:54
S15	1	("20010050096").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/27 15:43
S17	261	(fluid or liquid) same purge same cryogenic\$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 15:44
S18	115	((wet or aqueous) near\$4 clean\$4) same purge same cryogenic\$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 16:34
S19	1726	cryogenic\$4 and clean\$4 and (acetone or ethanol)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 16:40
S20	1245	cryogenic\$4 and clean\$4 and (acetone or ethanol) and (wafer or substrate or semiconductor or electronic)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 16:41
S21	14	cryogenic\$4 same clean\$4 same (acetone or ethanol) same (wafer or substrate or semiconductor or electronic)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 17:55
S22	5588	(size) same (residue or contaminant) same (substrate or semiconductor or electronic or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/27 18:01
S23	52	("0.5" near2 (micrometer or mu)) same (residue or contaminant) same (substrate or semiconductor or electronic or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/28 09:42
S24	96	((micrometer or mu) with (residue or contaminant)) same (substrate or semiconductor or electronic or wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/28 11:15
S25	2259	(134/1).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/28 11:15

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S26	756	(134/1.1).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/28 11:15
S27	2041	(134/26).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/09/28 11:15
S28	2	S25 and S26 and S27 and cryogenic\$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/28 11:15
S29	13	S25 and S26 and S27	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/28 11:16